## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

#### **General Description**

The MAX14955 dual equalizer/redriver improves PCI Express<sup>®</sup> (PCIe) signal integrity by providing programmable input equalization. This feature reduces deterministic jitter and redrives circuitry to reestablish deemphasis, which compensates for circuit-board loss at high frequencies. The device permits optimal placement of key PCIe components and allows for longer runs of stripline, microstrip, or cable.

The device contains two identical channels capable of equalizing PCIe Gen III (8GT/s), Gen II (5GT/s), and Gen I (2.5GT/s) signals and features electrical idle and receiver detection.

The MAX14955 is available in a small, 40-pin, 5.0mm x 5.0mm TQFN package with flow-through traces for optimal layout and minimal space requirements. The device is specified over the  $-40^{\circ}$ C to  $+85^{\circ}$ C extending operating temperature range.

#### **Applications**

- Industrial/Embedded PCs
- Computer on Modules
- Carrier Boards
- Test Equipment
- Rack Server Industrial PCs
- Medical Equipment

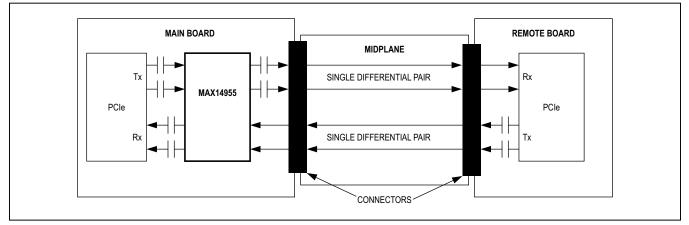
### **Typical Operating Circuit**

#### **Benefits and Features**

- Fully Integrated for Ease of Use and Design Flexibility
  - Optimized for PCIe Gen III (8.0GT/s), Gen II (5.0GT/s), Gen I (2.5 GT/s) Compatible
  - Four Levels of Input Equalization up to 16dB
  - Eight Levels of Output Deemphasis up to 9dB
- High Level of Performance to Overcome Noise in Lossy Channels
  - Random Jitter: 0.5ps<sub>RMS</sub> (typ)
  - Deterministic Jitter: 7psp-p (typ)
  - · Equalization Permits Placement Up to 30in FR4
- Robust Solution for Harsh Environments
  - Industrial Temperature Rated: -40°C to +85°C
  - ±4kV Human Body Model (HBM) Protection on All Pins
  - Housed in a Flow-Through (5mm x 5mm) TQFN
    Package for Resistance to Vibration/Shocks

#### Ordering Information appears at end of data sheet.

For related parts and recommended products to use with this part, refer to www.maximintegrated.com/MAX14955.related.



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## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

### **Absolute Maximum Ratings**

(Voltages referenced to GND.)	
V <sub>CC</sub>	0.3V to +4.0V
All Other Pins (Note 1)	0.3V to (V <sub>CC</sub> + 0.3V)
Continuous Current IN_P, IN_M,	
OUT_P, OUT_M	±30mA
Peak Current IN_P, IN_M, OUT_P, OU	T_M
(pulsed for 1µs, 1% duty cycle)	±100mA

Note 1: All I/O pins are clamped by internal diodes.

Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
TQFN (derate 35.7mW/°C above +70°C)	2857mW
Operating Temperature Range	40°C to +85°C
Junction Temperature Range	-40°C to +150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### Package Thermal Characteristics (Note 2)

#### TQFN

**Note 2:** Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/thermal-tutorial</u>.

### **Electrical Characteristics**

 $(V_{CC} = +3.0V \text{ to } +3.6V, C_{CL} = 200\text{nF} \text{ coupling capacitor on each output, } R_L = 50\Omega \text{ on each output, } T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ noted. Typical values are at  $V_{CC} = +3.3V$  and  $T_A = +25^{\circ}\text{C}.$ ) (Note 3)

PARAMETER	SYMBOL		CONDITIONS	MIN	TYP	MAX	UNITS	
DC PERFORMANCE				•				
Power-Supply Range	V <sub>CC</sub>			3.0	3.3	3.6	V	
			OEQ_2 = OEQ_1 = OEQ_0 = GND		102	135		
			$OEQ_2 = OEQ_1 = GND,$ $OEQ_0 = V_{CC}$		106	140		
			$OEQ_2 = OEQ_0 = GND,$ $OEQ_1 = V_{CC}$		107	140		
		OEQ_2 = GND, OEQ_1 = OEQ_0 = V <sub>CC</sub>		125	160			
Supply Current	Icc		EN = V <sub>CC</sub>	$OEQ_2 = V_{CC}, OEQ_1 = OEQ_0 = GND$		106	140	mA
			$OEQ_2 = OEQ_0 = V_{CC},$ $OEQ_1 = GND$		132	170		
				$OEQ_2 = OEQ_1 = V_{CC},$ $OEQ_0 = GND$		140	180	
			$OEQ_2 = OEQ_1 = OEQ_0$ = V <sub>CC</sub>		165	210		

## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

### **Electrical Characteristics (continued)**

 $(V_{CC} = +3.0V \text{ to } +3.6V, C_{CL} = 200nF \text{ coupling capacitor on each output, } R_L = 50\Omega \text{ on each output, } T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ noted. Typical values are at  $V_{CC} = +3.3V$  and  $T_A = +25^{\circ}C.$ ) (Note 3)

PARAMETER	SYMBOL		CONDITIONS	MIN	ТҮР	MAX	UNITS
			OEQ_2 = OEQ_1 = OEQ_0 = GND		57	80	-
			$OEQ_2 = OEQ_1 = GND,$ $OEQ_0 = V_{CC}$		61	85	
			$OEQ_2 = OEQ_0 = GND,$ $OEQ_1 = V_{CC}$		62	85	
Standby Current	lozov	EN = GND	OEQ_2 = GND, OEQ_1 = OEQ_0 = V <sub>CC</sub>		75	100	mA
Stanuby Current	ISTBY	EN - GND	OEQ_2 = V <sub>CC</sub> , OEQ_1 = OEQ_0 = GND		62	80	mA
			$OEQ_2 = OEQ_0 = V_{CC},$ $OEQ_1 = GND$		85	110	
			$OEQ_2 = OEQ_1 = V_{CC},$ $OEQ_0 = GND$		92	120	
			OEQ_2 = OEQ_1 = OEQ_0 = V <sub>CC</sub>		120	150	
Differential Input Impedance	Z <sub>RX-DIFF-</sub> DC	DC		80	100	120	Ω
Differential Output Impedance	Z <sub>TX-DIFF-</sub> DC	DC		80	100	120	Ω
Common-Mode Resistance to GND, Input Termination Not Powered	Z <sub>RX-HIGH-</sub> IMP-DC	-150mV ≤ V <sub>I</sub>	N_CM ≤ +200mV	50			kΩ
Common-Mode Resistance to GND, Input Termination Powered	Z <sub>RX-DC</sub>			20	25	30	Ω
Output Short-Circuit Current	I <sub>TX-SHORT</sub>	Single-ender	d (Note 4)	90			mA
Common-Mode Delta, Between Active and Idle States	V <sub>TX-CM-DC-</sub> ACTIVE-IDLE- DELTA					100	mV
DC Output Offset, During Active State	V <sub>TX-</sub> ACTIVE- DIFF-DC	I(V <sub>OUT_P</sub> - V	Όυτ_Μ)Ι			65	mV
DC Output Offset, During Electrical Idle	V <sub>TX-IDLE-</sub> DIFF-DC	(V <sub>OUT_P</sub> - V	′ουτ_м)Ι			65	mV

## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

### **Electrical Characteristics (continued)**

 $(V_{CC} = +3.0V \text{ to } +3.6V, C_{CL} = 200nF \text{ coupling capacitor on each output, } R_L = 50\Omega \text{ on each output, } T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ noted. Typical values are at  $V_{CC} = +3.3V$  and  $T_A = +25^{\circ}C.$ ) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
AC PERFORMANCE (Note 4)						
		f = 0.05GHz to 1.25GHz	9			dB
Input Return Loss, Differential	RL <sub>RX-DIFF</sub>	f = 1.25GHz to 2.5GHz	8			dB
		f = 2.5GHz to 4GHz	5			dB
Input Return Loss, Common		f = 0.05GHz to 2.5GHz	6			dB
Mode	RL <sub>RX-CM</sub>	f = 2.5GHz to 4GHz	4			dB
		f = 0.05GHz to 1.25GHz	10			dB
Output Return Loss, Differential	RL <sub>TX-DIFF</sub>	f = 1.25GHz to 2.5GHz	8			dB
		f = 2.5GHz to 4GHz	4			dB
Output Return Loss, Common		f = 0.05GHz to 2.5GHz	6			dB
Mode	RL <sub>TX-CM</sub>	f = 2.5GHz to 4GHz	4			dB
Redriver-Operation Differential Input-Signal Range	V <sub>RX-DIFF-</sub> PP		100		1200	mV <sub>P-P</sub>
Full-Swing Differential Output Voltage (No Deemphasis)	V <sub>TX-DIFF-</sub> PP	$2 \times  (V_{OUT_P} - V_{OUT_M}) ,$ OEQ_2 = OEQ_1 = OEQ_0 = GND	800	1000	1400	mV <sub>P-P</sub>
Output Deemphasis Ratio, 0dB	V <sub>TX-DE-</sub> RATIO-0dB	OEQ_2 = OEQ_1 = OEQ_0 = GND, Figure 1		0		dB
Output Deemphasis Ratio, 3.5dB	V <sub>TX-DE-</sub> RATIO-3.5dB	OEQ_2 = OEQ_1 = GND, OEQ_0 = V <sub>CC</sub> , Figure 1		3.5		dB
Output Deemphasis Ratio, 6dB	V <sub>TX-DE</sub> - RATIO-6dB	OEQ_2 = OEQ_0 = GND, OEQ_1 = V <sub>CC</sub> , Figure 1		6		dB
Output Deemphasis Ratio, 6dB with Higher Amplitude	V <sub>TX-DE-HA-</sub> RATIO-6dB	OEQ_2 = GND, OEQ_1 = OEQ_0 = V <sub>CC</sub> , Figure 1		6		dB
Output Deemphasis Ratio, 3.5dB with Preshoot	V <sub>TX-DE-PS-</sub> RATIO-3.5dB	OEQ_2 = V <sub>CC</sub> , OEQ_1 = OEQ_0 = GND, Figure 1		3.5		dB
Output Deemphasis Ratio, 6dB with Preshoot	V <sub>TX-DE-PS-</sub> RATIO-6dB	OEQ_2 = OEQ_0 = V <sub>CC</sub> , OEQ_1 = GND, Figure 1		6		dB
Output Deemphasis Ratio, 9dB with Preshoot	V <sub>TX-DE-PS-</sub> RATIO-9dB	OEQ_2 = OEQ_1 = V <sub>CC</sub> , OEQ_0 = GND, Figure 1		9		dB
Output Deemphasis Ratio, 9dB with Preshoot and Higher Amplitude	V <sub>TX-DE-PS-</sub> HA-RATIO- 9dB	OEQ_2 = OEQ_1 = OEQ_0 = V <sub>CC</sub> , Figure 1	9		dB	
Input Equalization, 5dB	V <sub>RX-EQ-5dB</sub>	INEQ_1 = INEQ_0 = GND (Note 5)		5		dB

## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

### **Electrical Characteristics (continued)**

 $(V_{CC} = +3.0V \text{ to } +3.6V, C_{CL} = 200nF \text{ coupling capacitor on each output, } R_L = 50\Omega \text{ on each output, } T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ noted. Typical values are at  $V_{CC} = +3.3V$  and  $T_A = +25^{\circ}C.$ ) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Equalization, 8dB	V <sub>RX-EQ-8dB</sub>	INEQ_1 = GND, INEQ_0 = V <sub>CC</sub> (Note 5)		8		dB
Input Equalization, 12dB	V <sub>RX-EQ-</sub> 12dB	INEQ_1 = V <sub>CC</sub> , INEQ_0 = GND (Note 5)		12		dB
Input Equalization, 16dB	V <sub>RX-EQ-</sub> 16dB	INEQ_1 = INEQ_0 = V <sub>CC</sub> (Note 5)		16		dB
Output Common-Mode Voltage	V <sub>TX-CM-AC-</sub> PP	$\begin{array}{l} MAX(V_{OUT_{P}} + V_{OUT_{M}})/2 - MIN(V_{OUT_{P}} \\ + V_{OUT_{M}})/2 \end{array}$			100	mV <sub>P-P</sub>
Propagation Delay	t <sub>PD</sub>		120	160	240	ps
Rise/Fall Time	t <sub>TX-RISE-</sub> FALL	(Note 6)	20			ps
Rise/Fall Time Mismatch	t <sub>TX-RF-</sub> MISMATCH	(Note 6)			20	ps
Deterministic Jitter	t <sub>TX-DJ-DD</sub>	K28.5 pattern, AC-coupled, $R_L = 50\Omega$ , no deemphasis, no preshoot, data rate = 8GT/s		7	23.5	ps <sub>P-P</sub>
Random Jitter	t <sub>TX-RJ-DD</sub>	D10.2 pattern, no deemphasis, no preshoot, data rate = 8GT/s		0.5	1.5	ps <sub>RMS</sub>
Electrical Idle Entry Delay	t <sub>TX-IDLE-</sub> SET-TO-IDLE	From input to output, D10.2 pattern, data rate = 1GT/s		5		ns
Electrical Idle Exit Delay	t <sub>TX-IDLE-</sub> TO-DIFF- DATA	From input to output, D10.2 pattern, data rate = 1GT/s		5		ns
Electrical Idle Detect Threshold	V <sub>TX-IDLE-</sub>	D10.2 pattern, data rate = 1GT/s (Note 3)	50	112	190	m) (
Electrical fulle Detect Threshold	THRESH	D10.2 pattern, data rate = 1GT/s to 8GT/s		112		mV <sub>P-P</sub>
Output Voltage During Electrical Idle (AC)	V <sub>TX-IDLE-</sub> DIFF-AC-P	I(Vout_p - Vout_m)I			20	mV <sub>P-P</sub>
Receiver-Detect Pulse Amplitude	V <sub>TX-RCV-</sub> DETECT	Voltage change in positive direction		600		mV
Receiver-Detect Pulse Width				100		ns
Receiver-Detect Retry Period				200		ns
CONTROL LOGIC	n					
Input-Logic Level Low	VIL				0.6	V
Input-Logic Level High	V <sub>IH</sub>		1.4			V
Input-Logic Hysteresis	V <sub>HYST</sub>			0.1	-	V
Input Pulldown Resistance	R <sub>PD</sub>		200	375		kΩ
ESD PROTECTION	'n					
ESD Voltage		Human Body Model (HBM)		±4		kV

## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

#### **Electrical Characteristics (continued)**

 $(V_{CC} = +3.0V \text{ to } +3.6V, C_{CL} = 200\text{nF} \text{ coupling capacitor on each output, } R_L = 50\Omega \text{ on each output, } T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ noted. Typical values are at  $V_{CC} = +3.3V$  and  $T_A = +25^{\circ}\text{C}.$ ) (Note 3)

- Note 3: All devices are 100% production tested at T<sub>A</sub> = +85°C. Specifications over operating temperature range are guaranteed by design.
- Note 4: Guaranteed by design, unless otherwise noted.
- Note 5: Equivalent to same amount of deemphasis driving the input.
- Note 6: Rise and fall times are measured using 20% and 80% levels.

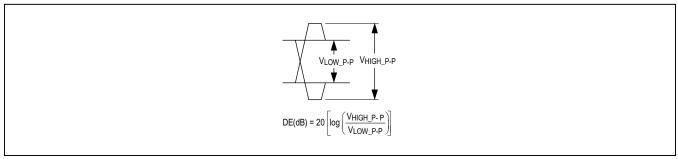
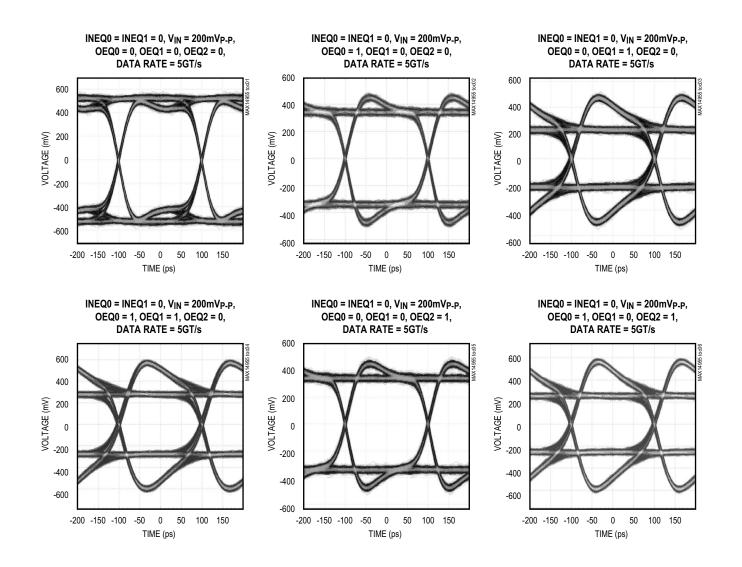


Figure 1. Illustration of Output Deemphasis

## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

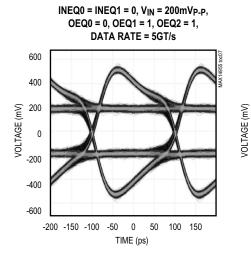
### **Typical Operating Characteristics**

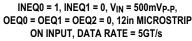


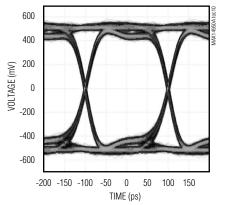
## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

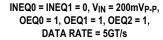
#### **Typical Operating Characteristics (continued)**

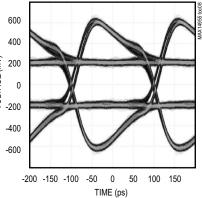
(V<sub>CC</sub> = +3.3V,  $T_A$  = +25°C, unless otherwise noted.)



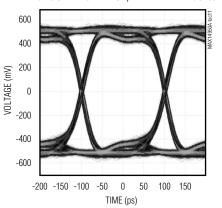




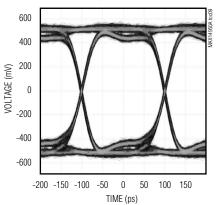




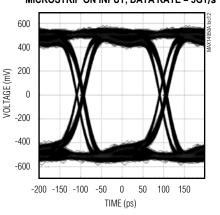
INEQ0 = 0, INEQ1 = 1, VIN = 500mVP-P, OEQ0 = OEQ1 = OEQ2 = 0, 18in MICROSTRIP ON INPUT, DATA RATE = 5GT/s



INEQ0 = 1, INEQ1 = 0,  $V_{IN}$  = 500mVP-P, OEQ0 = OEQ1 = OEQ2 = 0, 6in MICROSTRIP ON INPUT, DATA RATE = 5GT/s



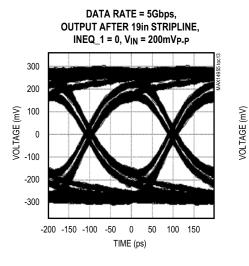
INEQ0 = 1, INEQ1 = 1, V<sub>IN</sub> = 500mV<sub>P-P</sub>, OEQ0 = OEQ1 = OEQ2 = 0, 24in MICROSTRIP ON INPUT, DATA RATE = 5GT/s

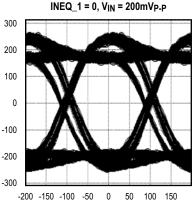


## Single-Lane PCIe Gen III Redriver with Equalization and Extended **Temperature Operation**

### **Typical Operating Characteristics (continued)**

(V<sub>CC</sub> = +3.3V,  $T_A$  = +25°C, unless otherwise noted.)



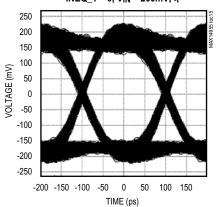


DATA RATE = 5Gbps,

**OUTPUT AFTER 19in STRIPLINE,** 

TIME (ps)

DATA RATE = 5Gbps, **OUTPUT AFTER 19in STRIPLINE,** INEQ\_1 = 0, VIN = 200mVP-P



INEQ\_1 = 0, VIN = 200mVP-P 300 200 100 VOLTAGE (mV) 0 -100

> 0 50

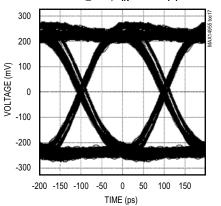
TIME (ps)

100 150

DATA RATE = 5Gbps,

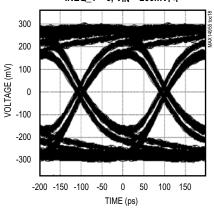
**OUTPUT AFTER 19in STRIPLINE,** 

DATA RATE = 5Gbps, **OUTPUT AFTER 19in STRIPLINE,** 



INEQ\_1 = 0, VIN = 200mVP-P

DATA RATE = 5Gbps, **OUTPUT AFTER 19in STRIPLINE,** INEQ\_1 = 0, VIN = 200mVP-P



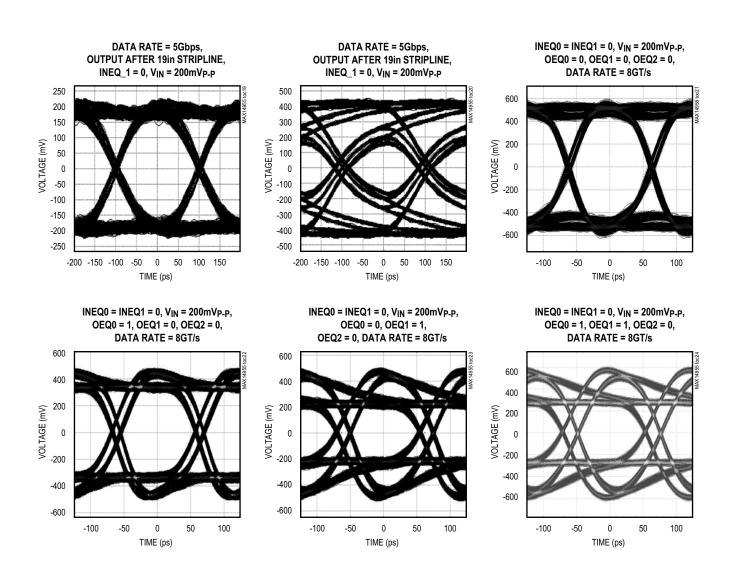
-200

-300

-200 -150 -100 -50

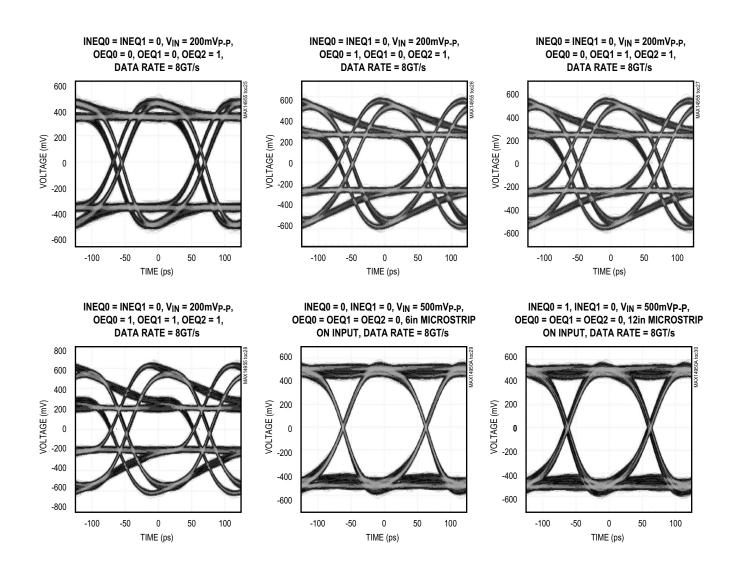
## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

### **Typical Operating Characteristics (continued)**



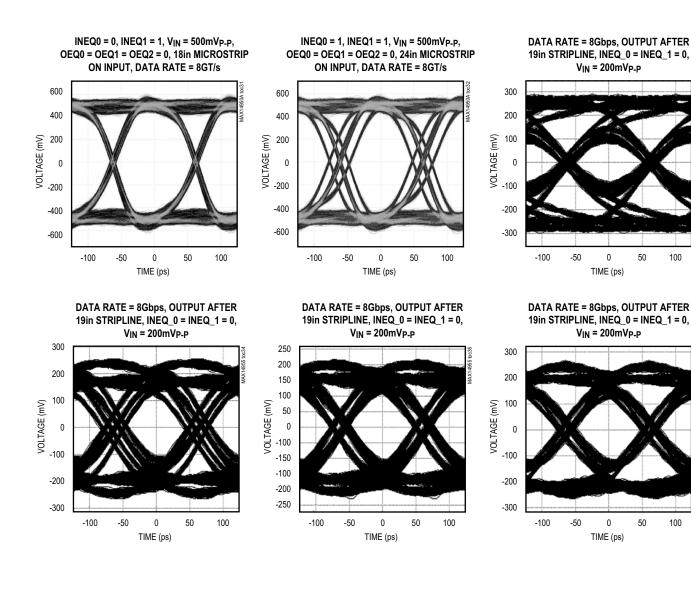
### Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

### **Typical Operating Characteristics (continued)**



## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

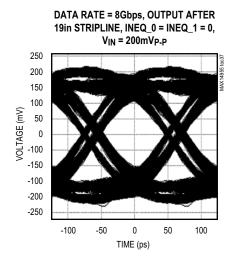
### **Typical Operating Characteristics (continued)**



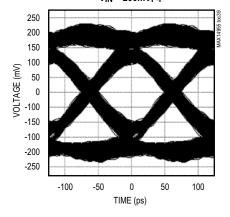
## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

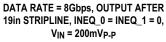
### **Typical Operating Characteristics (continued)**

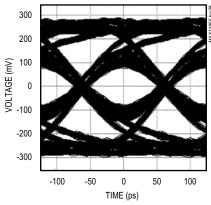
(V<sub>CC</sub> = +3.3V, T<sub>A</sub> = +25°C, unless otherwise noted.)



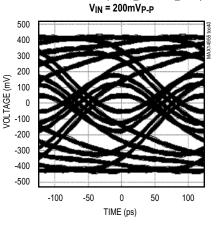
#### DATA RATE = 8Gbps, OUTPUT AFTER 19in STRIPLINE, INEQ\_0 = INEQ\_1 = 0, $V_{IN}$ = 200mVP-P





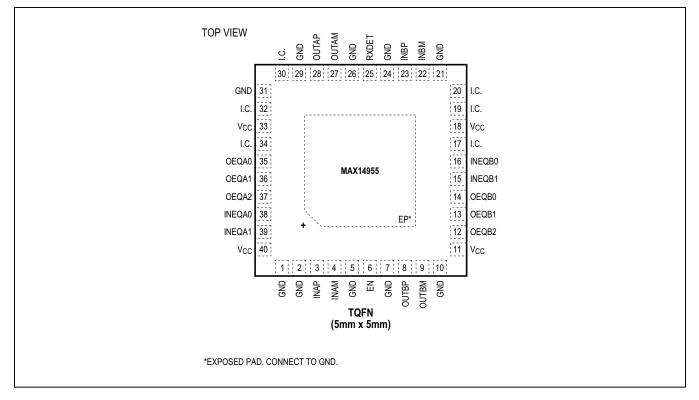


DATA RATE = 8Gbps, OUTPUT AFTER 19in STRIPLINE, INEQ\_0 = INEQ\_1 = 0,



## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

## **Pin Configuration**



### **Pin Description**

PIN	NAME	FUNCTION
1, 2, 5, 7, 10, 21, 24, 26, 29, 31	GND	Ground
3	INAP	Noninverting Input, Channel A
4	INAM	Inverting Input, Channel A
6	EN	Enable Input. Drive EN low for standby mode. Drive EN high for normal mode. EN has a $375k\Omega$ (typ) internal pulldown resistor.
8	OUTBP	Noninverting Output, Channel B
9	OUTBM	Inverting Output, Channel B
11, 18, 33, 40	V <sub>CC</sub>	Power-Supply Input. Bypass $V_{CC}$ to GND with 0.1µF and 0.01µF capacitors in parallel as close as possible to the device.
12	OEQB2	Output Deemphasis Control MSB, Channel B. OEQB2 has a $375k\Omega$ (typ) internal pulldown resistor.
13	OEQB1	Output Deemphasis Bit 1, Channel B. OEQB1 has a 375k $\Omega$ (typ) internal pulldown resistor.

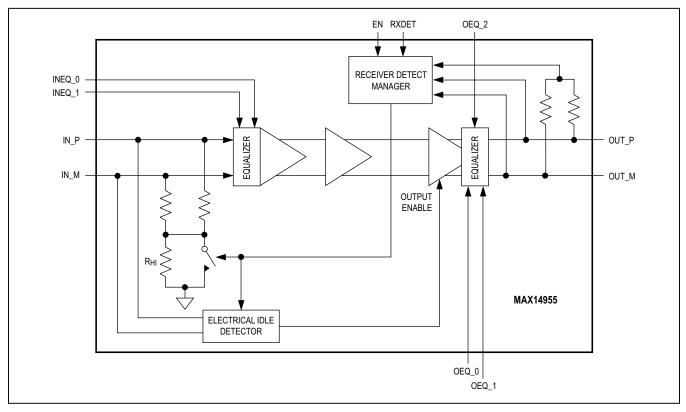
# Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

## **Pin Description (continued)**

PIN	NAME	FUNCTION
14	OEQB0	Output Deemphasis Control LSB, Channel B. OEQB0 has a $375k\Omega$ (typ) internal pulldown resistor.
15	INEQB1	Input Equalization Control MSB, Channel B. INEQB1 has a $375k\Omega$ (typ) internal pulldown resistor.
16	INEQB0	Input Equalization Control LSB, Channel B. INEQB0 has a 375k $\Omega$ (typ) internal pulldown resistor.
17, 19, 20, 30, 32, 24	I.C.	Internally Connected. Leave I.C. unconnected.
22	INBM	Inverting Input, Channel B
23	INBP	Noninverting Input, Channel B
25	RXDET	Receiver Detection Control Bit. Toggle RXDET to initiate receiver detection. RXDET has a $375k\Omega$ (typ) internal pulldown resistor.
27	OUTAM	Inverting Output, Channel A
28	OUTAP	Noninverting Output, Channel A
35	OEQA0	Output Deemphasis Control LSB, Channel A. OEQA0 has a $375 k\Omega$ (typ) internal pulldown resistor.
36	OEQA1	Output Deemphasis Control Bit 1, Channel A. OEQA1 has a $375k\Omega$ (typ) internal pulldown resistor.
37	OEQA2	Output Deemphasis Control MSB, Channel A. OEQA2 has a 375k $\Omega$ (typ) internal pulldown resistor.
38	INEQA0	Input Equalization Control LSB, Channel A. INEQA0 has a 375k $\Omega$ (typ) internal pulldown resistor.
39	INEQA1	Input Equalization Control MSB, Channel A. INEQA1 has a 375k $\Omega$ (typ) internal pulldown resistor.
_	EP	Exposed Pad. Internally connected to GND. Connect EP to a large ground plane to maximize thermal performance and ground conductivity to the device. Do not use EP as the only GND connection.

## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

### **Functional Diagram**



#### **Detailed Description**

The MAX14955 dual equalizer/redriver supports Gen III (8GT/s), Gen II (5GT/s), and Gen I (2.5GT/s) PCIe data rates. The device contains two identical drivers with idle/receive detect on each lane and equalization/ deemphasis/preshoot to compensate for circuit board loss. Programmable input equalization circuitry reduces deterministic jitter, improving signal integrity. The device features programmable output deemphasis/preshoot, permitting optimal placement of key PCIe components and longer runs of stripline, microstrip, or cable.

#### **Programmable Input Equalization**

Programmable input equalization for channel A is controlled by two bits: INEQA1 and INEQA0 and for channel B is controlled by two bits: INEQB1 and INEQB0 (Table 1.)

#### **Programmable Output Deemphasis**

Programmable output deemphasis/preshoot for channel A is controlled by the three bits: OEQA2, OEQA1, OEQA0 and channel B is controlled by the three bits: OEQB2, OEQB1, OEQB0 (Table 2.)

#### **Receiver Detection**

The device features receiver detection on each channel. Upon initial power-up, if EN is high, receiver detection initializes. Receiver detection can also be initiated on a rising or falling edge of the RXDET input when EN is high. During this time, the part remains in low-power standby mode and the outputs are squelched, despite the logichigh state of EN. Until a channel has detected a receiver, the receiver detection repeats indefinitely on each channel. If a channel detects a receiver, the other channel is limited to a few retries. Upon receiver detection, input common-mode termination and electrical idle detection are enabled (Table 3.)

#### **Table 1. Input Equalization**

INEQ_1	INEQ_0	INPUT EQUALIZATION (dB)
0	0	5
0	1	8
1	0	12
1	1	16

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OEQ_2	OEQ_1	OEQ_0	OUTPUT DEEMPHASIS RATIO (dB)	PEAK-TO-PEAK SWING	PRESHOOT
0	0	0	0	1.0V	No
0	0	1	3.5	1.0V	No
0	1	0	6	1.0V	No
0	1	1	6	1.2V	No
1	0	0	3.5	1.0V	Yes
1	0	1	6	1.0V	Yes
1	1	0	9	0.9V	Yes
1	1	1	9	1.0V	Yes

#### Table 2. Output Deemphasis/Preshoot

#### **Table 3. Receiver Detection Input Function**

RXDET	EN	DESCRIPTION
Х	0	Receiver detection is inactive.
х	1	Following a rising edge of EN signal, indefinite retry until a receiver is detected for at least one channel. Retries stop a few times after any channel is detected.
Rising/falling edge	1	Initiate receiver detection.

X = Don't care.

#### **Electrical Idle Detection**

The device features electrical idle detection to prevent unwanted noise from being redriven at the output. When the device detects the differential input has fallen below the electrical idle low threshold, it squelches the output. For differential input signals that are above the electrical idle high threshold, the device turns on the output and redrives the signal.

#### **Applications Information**

#### Layout

Circuit board layout and design can significantly affect the performance of the device. Use good high-frequency design techniques, including minimizing ground inductance and using controlled-impedance transmission lines on data signals. Power-supply decoupling capacitors must be placed as close as possible to V<sub>CC</sub>. Always connect V<sub>CC</sub> to a power plane. It is recommended to run receive and transmit on different layers to minimize crosstalk.

#### **Exposed-Pad Package**

The exposed-pad, 40-pin TQFN package incorporates features that provide a very low thermal resistance path for heat removal from the IC. The exposed pad on the device must be soldered to the circuit board ground plane for proper thermal performance. For more information on exposed-pad packages, refer to Maxim Application Note HFAN-08.1: *Thermal Considerations of QFN and Other Exposed-Paddle Packages*.

#### **Power-Supply Sequencing**

Caution: Do not exceed the absolute maximum ratings because stresses beyond the listed ratings can cause permanent damage to the device.

Proper power-supply sequencing is recommended for all devices. Always apply GND then  $V_{CC}$  before applying signals, especially if the signal is not current limited.

### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX14955ETL+	-40°C to +85°C	40 TQFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package. \*EP = Exposed pad.

#### **Chip Information**

PROCESS: BICMOS

## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

#### **Package Information**

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
40 TQFN-EP	T4055+2	<u>21-0140</u>	<u>90-0002</u>

## Single-Lane PCIe Gen III Redriver with Equalization and Extended Temperature Operation

### **Revision History**

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
0	3/13	Initial release	—

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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